# **BGU7004**

# SiGe:C Low Noise Amplifier MMIC for GPS, GLONASS and Galileo

Rev. 1 — 5 July 2011

**Product data sheet** 

# 1. Product profile

## 1.1 General description

The BGU7004 is an AEC-Q100 qualified Low Noise Amplifier (LNA) for GNSS receiver applications in a plastic leadless 6-pin, extremely small SOT886 package. The BGU7004 requires only one external matching inductor and one external decoupling capacitor.

The BGU7004 adapts itself to the changing environment resulting from co-habitation of different radio systems in modern cellular handsets. It has been designed for low power consumption and optimal performance when jamming signals from co-existing cellular transmitters are present. At low jamming power levels it delivers 16.5 dB gain at a noise figure of 0.85 dB. During high jamming power levels, resulting for example from a cellular transmit burst, it temporarily increases its bias current to improve sensitivity.

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

#### 1.2 Features and benefits

- AEC-Q100 qualified (see Section 9.1)
- Covers full GNSS L1 band, from 1559 MHz to 1610 MHz
- Noise figure (NF) = 0.85 dB
- Gain 16.5 dB
- High input 1 dB compression point P<sub>i</sub> (1dB) of –11 dBm
- High out of band IP3<sub>i</sub> of 9 dBm
- Supply voltage 1.5 V to 2.85 V
- Power-down mode current consumption < 1 μA</p>
- Optimized performance at low supply current of 4.5 mA
- Integrated matching for the output
- Requires only one input matching inductor and one supply decoupling capacitor
- Input and output DC decoupled
- ESD protection on all pins (HBM > 2 kV)
- Integrated temperature stabilized bias for easy design
- Small 6-pin leadless package 1 mm × 1.45 mm × 0.5 mm
- 110 GHz transit frequency SiGe:C technology



#### SiGe:C Low Noise Amplifier MMIC for GPS

# 1.3 Applications

- LNA for GPS in automotive applications like Toll Collection and Emergency Call.
- LNA for GPS in smart phones, feature phones, tablet PCs, Personal Navigation Devices, Digital Still Cameras, Digital Video Cameras, RF Front End modules, complete GPS chipset modules and theft protection (laptop, ATM).

#### 1.4 Quick reference data

Table 1. Quick reference data

f = 1559 MHz to 1610 MHz;  $V_{CC}$  = 1.8 V;  $P_i$  < -40 dBm;  $T_{amb}$  = 25 °C; input matched to 50  $\Omega$  using a 5.6 nH inductor; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{CC}$	supply voltage	RF input AC coupled		1.5	-	2.85	V
I <sub>CC</sub>	supply current	$V_{ENABLE} \ge 0.8 \ V$					
		$P_i < -40 \text{ dBm}$		3.2	4.5	5.7	mΑ
		$P_i = -20 \text{ dBm}$		8.1	11.6	14.4	mΑ
$G_p$	power gain	$P_i < -40$ dBm, no jammer		14	16.5	19	dB
		$P_i = -20$ dBm, no jammer		15	17.5	20	dB
NF	noise figure	$P_i < -40$ dBm, no jammer	[1]	-	0.85	1.2	dB
		P <sub>i</sub> < -40 dBm, no jammer	[2]	-	0.9	1.3	dB
		$P_i = -20 \text{ dBm}$ , no jammer		-	1.2	1.6	dB
P <sub>i(1dB)</sub>	input power at 1 dB gain compression	f = 1559 MHz to 1610 MHz					
		V <sub>CC</sub> = 1.5 V		-15	-12	-	dBm
		V <sub>CC</sub> = 1.8 V		-14	-11	-	dBm
		V <sub>CC</sub> = 2.85 V		-11	-8	-	dBm
IP3 <sub>i</sub>	input third-order intercept point	f = 1.575 GHz					
		V <sub>CC</sub> = 1.5 V	[3]	5	8	-	dBm
		V <sub>CC</sub> = 1.8 V	[3]	5	9	-	dBm
		V <sub>CC</sub> = 2.85 V	[3]	5	12	-	dBm

<sup>[1]</sup> PCB losses are substracted.

# 2. Pinning information

Table 2. Pinning

	9	
Pin	Description	Simplified outline Graphic symbol
1	GND	
2	GND	1 2 3 4 5
3	RF_IN	3 - 6
4	V <sub>CC</sub>	
5	ENABLE	2 1 sym129
6	RF_OUT	6 5 4 sym129 bottom view

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**Product data sheet** 

<sup>[2]</sup> Including PCB losses.

<sup>[3]</sup>  $f_1 = 1713 \text{ MHz}$ ;  $f_2 = 1851 \text{ MHz}$ ;  $P_1 = P_2 = -30 \text{ dBm}$ .

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# 3. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
BGU7004	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886				

# 4. Marking

Table 4. Marking codes

Type number	Marking code
BGU7004	UY

# 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

supply voltage voltage on pin ENABLE	RF input AC coupled	-0.5	3.1	V
voltage on pin ENABLE	\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \			V
	$V_{CC} \ge 2.5 \text{ V}$	-0.5	3.1	V
	V <sub>CC</sub> < 2.5 V	<u>[2]</u> –0.5	$V_{CC} + 0.6$	V
voltage on pin RF_IN	DC			
	$V_{CC} \ge 3.0 \text{ V}$	<u>[3]</u> −0.5	3.6	V
	V <sub>CC</sub> < 3.0 V	[2][3] -0.5	$V_{CC} + 0.6$	V
voltage on pin RF_OUT	DC			
	$V_{CC} \ge 1.8 \text{ V}$	<u>[3]</u> −0.5	3.6	V
	V <sub>CC</sub> < 1.8 V	[2][3] -0.5	V <sub>CC</sub> + 1.8	V
input power		-	0	dBm
total power dissipation	$T_{sp} \le 130  ^{\circ}C$	[1]	55	mW
storage temperature		-65	150	°C
unction temperature		-	150	°C
i	voltage on pin RF_OUT  nput power otal power dissipation storage temperature	$\begin{tabular}{lll} \begin{tabular}{lll} \hline \textit{Voltage on pin RF_IN} & \hline DC & & & \\ \hline & V_{CC} \ge 3.0 \text{ V} & \\ \hline & V_{CC} < 3.0 \text{ V} & \\ \hline & \textit{Voltage on pin RF_OUT} & \hline DC & & \\ \hline & V_{CC} \ge 1.8 \text{ V} & \\ \hline & V_{CC} < 1.8 \text{ V} & \\ \hline & \text{onput power} & \\ \hline & \text{otal power dissipation} & T_{sp} \le 130 \text{ °C} & \\ \hline & \text{storage temperature} & \\ \hline \end{tabular}$	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$

<sup>[1]</sup>  $T_{sp}$  is the temperature at the soldering point of the emitter lead.

# 6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point		225	K/W

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<sup>[2]</sup> Due to internal ESD diode protection, the applied voltage should not exceed the specified maximum in order to avoid excess current.

<sup>[3]</sup> The RF input and RF output are AC coupled through internal DC blocking capacitors.

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# 7. Characteristics

#### Table 7. Characteristics

f = 1559 MHz to 1610 MHz;  $V_{CC}$  = 1.8 V;  $V_{ENABLE} \ge 0.8$  V;  $P_i$  < -40 dBm;  $T_{amb}$  = 25 °C; input matched to 50  $\Omega$  using a 5.6 nH inductor; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{CC}$	supply voltage	RF input AC coupled		1.5	-	2.85	V
I <sub>CC</sub>	supply current	V <sub>ENABLE</sub> ≥ 0.8 V					
		$P_i < -40 \text{ dBm}$		3.2	4.5	5.7	mΑ
		$P_i = -20 \text{ dBm}$		8.1	11.6	14.4	mΑ
		$V_{\text{ENABLE}} \leq 0.3 \text{ V}$		-	-	1	μΑ
T <sub>amb</sub>	ambient temperature			-40	+25	+125	°C
G <sub>p</sub>	power gain	T <sub>amb</sub> = 25 °C					
		P <sub>i</sub> < −40 dBm, no jammer		14	16.5	19	dB
		P <sub>i</sub> = −20 dBm, no jammer		15	17.5	20	dB
		$P_{jam} = -20 \text{ dBm}$ ; $f_{jam} = 850 \text{ MHz}$		15	17.5	20	dB
		$P_{jam} = -20 \text{ dBm}$ ; $f_{jam} = 1850 \text{ MHz}$		15	17.5	20	dB
		$-40  ^{\circ}\text{C} \le T_{amb} \le +125  ^{\circ}\text{C}$					
		P <sub>i</sub> < −40 dBm, no jammer		13	-	20	dB
		P <sub>i</sub> = −20 dBm, no jammer		14	-	21	dB
		$P_{jam} = -20 \text{ dBm}$ ; $f_{jam} = 850 \text{ MHz}$		14	-	21	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 1850 \text{ MHz}$		14	-	21	dB
RLin	input return loss	$P_i < -40 \text{ dBm}$		5	8	-	dB
		$P_i = -20 \text{ dBm}$		6	10	-	dB
RLout	output return loss	$P_i < -40 \text{ dBm}$		10	20	-	dB
		$P_i = -20 \text{ dBm}$		10	14	-	dB
ISL	isolation			20	23	-	dB
NF	noise figure	T <sub>amb</sub> = 25 °C					
		P <sub>i</sub> < −40 dBm, no jammer	[1]	-	0.85	1.2	dB
		P <sub>i</sub> < −40 dBm, no jammer	[2]	-	0.9	1.3	dB
		P <sub>i</sub> = −20 dBm, no jammer		-	1.2	1.6	dB
		$P_{jam} = -20 \text{ dBm}$ ; $f_{jam} = 850 \text{ MHz}$		-	1.1	1.5	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 1850 \text{ MHz}$		-	1.3	1.7	dB
		$-40~^{\circ}\text{C} \le T_{amb} \le +125~^{\circ}\text{C}$					
		P <sub>i</sub> < −40 dBm, no jammer		-	-	1.8	dB
		P <sub>i</sub> = −20 dBm, no jammer		-	-	2.0	dB
		$P_{jam} = -20 \text{ dBm}$ ; $f_{jam} = 850 \text{ MHz}$		-	-	1.9	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 1850 \text{ MHz}$		-	-	2.1	dB

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Table 7. Characteristics ... continued

f = 1559 MHz to 1610 MHz;  $V_{CC}$  = 1.8 V;  $V_{ENABLE} \ge 0.8$  V;  $P_i$  < -40 dBm;  $T_{amb}$  = 25 °C; input matched to 50  $\Omega$  using a 5.6 nH inductor; unless otherwise specified.

Symbol	Parameter	Conditions	N	Viin	Тур	Max	Unit
P <sub>i(1dB)</sub>	input power at 1 dB gain compression	f = 1559 MHz to 1610 MHz					
		V <sub>CC</sub> = 1.5 V	_	-15	-12	-	dBm
		V <sub>CC</sub> = 1.8 V	_	-14	-11	-	dBm
		V <sub>CC</sub> = 2.85 V	_	-11	-8	-	dBm
		f = 806 MHz to 928 MHz					
		V <sub>CC</sub> = 1.5 V	[3] _	-15	-12	-	dBm
		V <sub>CC</sub> = 1.8 V	[3] _	-14	-11	-	dBm
		V <sub>CC</sub> = 2.85 V	[3] _	-14	-11	-	dBm
		f = 1612 MHz to 1909 MHz					
		V <sub>CC</sub> = 1.5 V	[3] _	-13	-10	-	dBm
		V <sub>CC</sub> = 1.8 V	[3] _	-12	-9	-	dBm
		V <sub>CC</sub> = 2.85 V	[3] _	-10	-7	-	dBm
IP3 <sub>i</sub>	input third-order intercept point	f = 1.575 GHz					
		V <sub>CC</sub> = 1.5 V	[4] 5	5	8	-	dBm
		V <sub>CC</sub> = 1.8 V	<u>[4]</u> 5	5	9	-	dBm
		V <sub>CC</sub> = 2.85 V	<u>[4]</u> 5	5	12	-	dBm
t <sub>on</sub>	turn-on time		<u>[5]</u> _		-	2	μS
t <sub>off</sub>	turn-off time		<u>[5]</u> _		-	1	μS
K	Rollett stability factor		1	1	-	-	

<sup>[1]</sup> PCB losses are subtracted.

Table 8. ENABLE (pin 5) -40 °C ≤  $T_{amb}$  ≤ +125 °C; 1.5 V ≤  $V_{CC}$  ≤ 2.85 V

V <sub>ENABLE</sub> (V)	State
≤ 0.3	OFF
≥ 0.8	ON

<sup>[2]</sup> Including PCB losses.

<sup>[3]</sup> Out of band.

<sup>[4]</sup>  $f_1 = 1713 \text{ MHz}$ ;  $f_2 = 1851 \text{ MHz}$ ;  $P_1 = P_2 = -30 \text{ dBm}$ .

<sup>[5]</sup> Within 10 % of the final gain.

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# 8. Application information

### 8.1 GNSS LNA

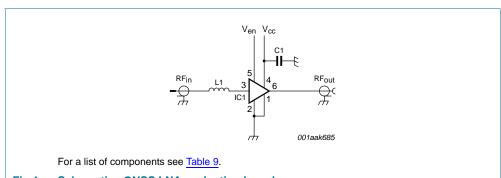
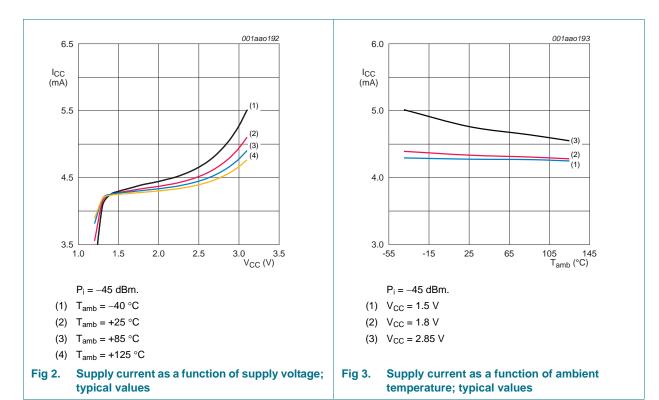


Fig 1. Schematics GNSS LNA evaluation board

**Table 9. List of components** For schematics see Figure 1.

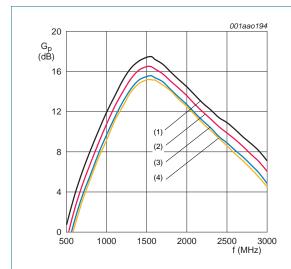
Component	Description	Value	Supplier	Remarks
C1	decoupling capacitor	1 nF	various	
IC1	BGU7004	-	NXP	
L1	high quality matching inductor	5.6 nH	Murata LQW15A	



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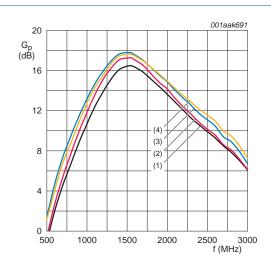
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$$V_{CC} = 1.8 \text{ V}; P_i = -45 \text{ dBm}.$$

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$
- (4)  $T_{amb} = +125 \, ^{\circ}C$

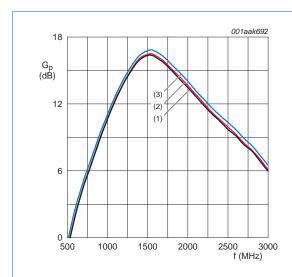
Fig 4. Power gain as a function of frequency; typical values



$$V_{CC}$$
 = 1.8 V;  $T_{amb}$  = 25 °C.

- (1)  $P_i = -45 \text{ dBm}$
- (2)  $P_i = -30 \text{ dBm}$
- (3)  $P_i = -20 \text{ dBm}$
- (4)  $P_i = -15 \text{ dBm}$

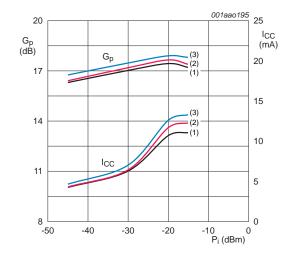
Fig 5. Power gain as a function of frequency; typical values



 $P_i = -45$  dBm;  $T_{amb} = 25$  °C.

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 6. Power gain as a function of frequency; typical values



 $T_{amb} = 25 \, ^{\circ}C; f = 1575 \, MHz.$ 

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

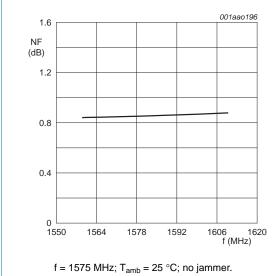
Fig 7. Power gain and supply current as function of input power; typical values

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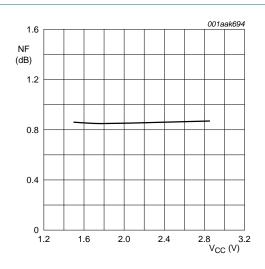
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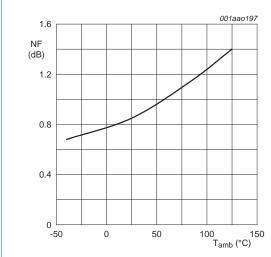


Noise figure as a function of supply voltage; Fig 8. typical values



f = 1575 MHz;  $T_{amb} = 25 \text{ °C}$ ; no jammer.

Fig 9. Noise figure as a function of supply voltage; typical values

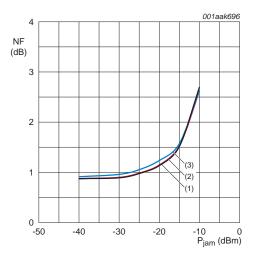


f = 1575 MHz;  $V_{CC} = 1.8 \text{ V}$ ; no jammer.

temperature; typical values



Fig 10. Noise figure as a function of ambient



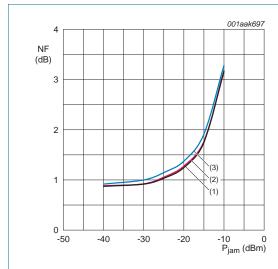
 $f_{jam} {=}~850$  MHz;  $T_{amb} = 25~^{\circ}\text{C}; \, f = 1575$  MHz.

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 11. Noise figure as a function of jamming power; typical values

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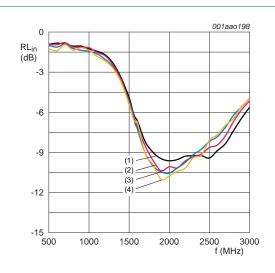
### **SiGe:C Low Noise Amplifier MMIC for GPS**



 $f_{jam}$  = 1850 MHz;  $T_{amb}$  = 25 °C; f = 1575 MHz.

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

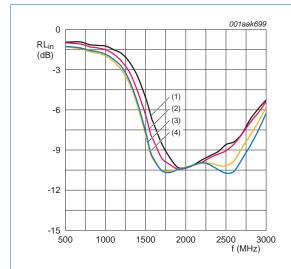
Fig 12. Noise figure as a function of jamming power; typical values



 $V_{CC} = 1.8 \text{ V}; P_i = -45 \text{ dBm}.$ 

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$
- (4)  $T_{amb} = +125 \, ^{\circ}C$

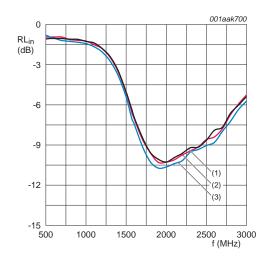
Fig 13. Input return loss as a function of frequency; typical values



 $V_{CC} = 1.8 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}.$ 

- (1)  $P_i = -45 \text{ dBm}$
- (2)  $P_i = -30 \text{ dBm}$
- (3)  $P_i = -20 \text{ dBm}$
- (4)  $P_i = -15 \text{ dBm}$

Fig 14. Input return loss as a function of frequency; typical values



 $P_i = -45$  dBm;  $T_{amb} = 25$  °C.

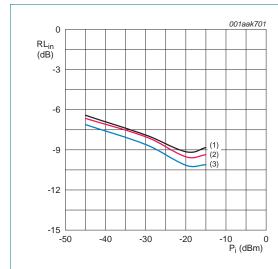
- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 15. Input return loss as a function of frequency; typical values

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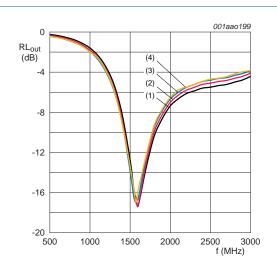
### **SiGe:C Low Noise Amplifier MMIC for GPS**



$$T_{amb} = 25 \, ^{\circ}C; f = 1575 \, MHz.$$

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

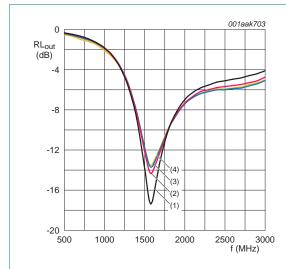
Fig 16. Input return loss as a function of input power; typical values



$$V_{CC} = 1.8 \text{ V}; P_i = -45 \text{ dBm}.$$

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$
- (4)  $T_{amb} = +125 \, ^{\circ}C$

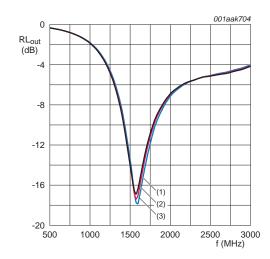
Fig 17. Output return loss as a function of frequency; typical values



 $V_{CC} = 1.8 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}.$ 

- (1)  $P_i = -45 \text{ dBm}$
- (2)  $P_i = -30 \text{ dBm}$
- (3)  $P_i = -20 \text{ dBm}$
- (4)  $P_i = -15 \text{ dBm}$

Fig 18. Output return loss as a function of frequency; typical values



 $P_i = -45$  dBm;  $T_{amb} = 25$  °C.

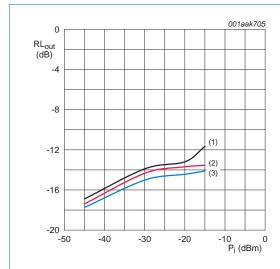
- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 19. Output return loss as a function of frequency; typical values

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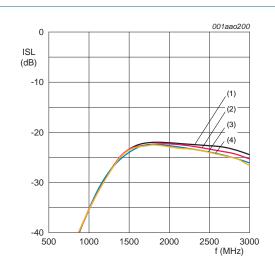
### **SiGe:C Low Noise Amplifier MMIC for GPS**



$$T_{amb} = 25 \, ^{\circ}C; f = 1575 \, MHz.$$

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

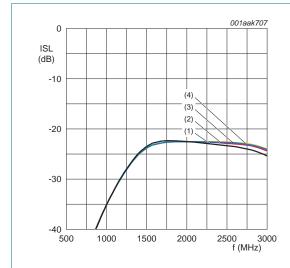
Fig 20. Output return loss as a function of input power; typical values



$$V_{CC} = 1.8 \text{ V}; P_i = -45 \text{ dBm}.$$

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$
- (4)  $T_{amb} = +125 \, ^{\circ}C$

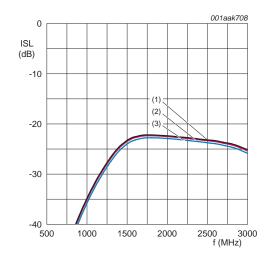
Fig 21. Isolation as a function of frequency; typical values



 $V_{CC} = 1.8 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}.$ 

- (1)  $P_i = -45 \text{ dBm}$
- (2)  $P_i = -30 \text{ dBm}$
- (3)  $P_i = -20 \text{ dBm}$
- (4)  $P_i = -15 \text{ dBm}$

Fig 22. Isolation as a function of frequency; typical values



 $P_i = -45$  dBm;  $T_{amb} = 25$  °C.

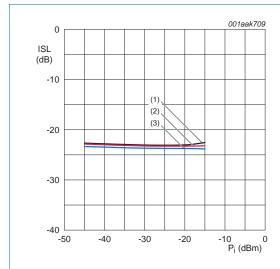
- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 23. Isolation as a function of frequency; typical values

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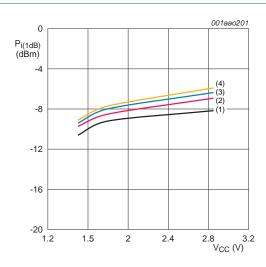


 $T_{amb} = 25 \, ^{\circ}C; f = 1575 \, MHz.$ 

(1) 
$$V_{CC} = 1.5 \text{ V}$$

- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 24. Isolation as a function of input power; typical values



f = 850 MHz.

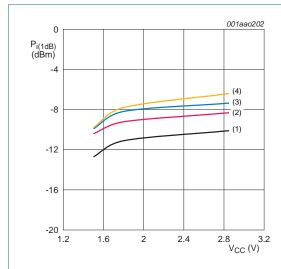
(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = +25 \, ^{\circ}C$$

(3) 
$$T_{amb} = +85 \, ^{\circ}C$$

(4)  $T_{amb} = +125 \, ^{\circ}C$ 

Fig 25. Input power at 1 dB gain compression as a function of supply voltage; typical values



f = 1850 MHz.

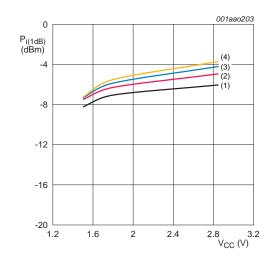
(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = +25 \, ^{\circ}C$$

(3)  $T_{amb} = +85 \, ^{\circ}C$ 

(4)  $T_{amb} = +125 \, ^{\circ}C$ 

Fig 26. Input power at 1 dB gain compression as a function of supply voltage; typical values



f = 1575 MHz.

(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = +25 \, ^{\circ}C$$

(3)  $T_{amb} = +85 \, ^{\circ}C$ 

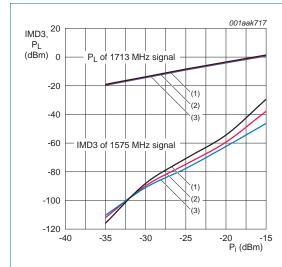
(4) 
$$T_{amb} = +125 \, {}^{\circ}C$$

Fig 27. Input power at 1 dB gain compression as a function of supply voltage; typical values

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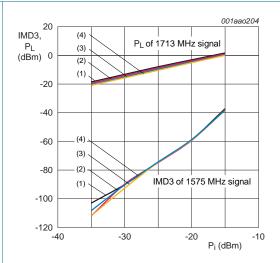
#### SiGe:C Low Noise Amplifier MMIC for GPS



 $f = 1575 \text{ MHz}; f_1 = 1713 \text{ MHz}; f_2 = 1851 \text{ MHz}; T_{amb} = 25 \,^{\circ}\text{C}.$ 

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

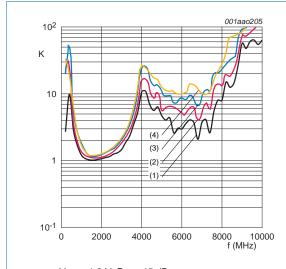
Fig 28. Third order intermodulation distortion and output power as function of input power; typical values



 $f = 1575 \text{ MHz}; f_1 = 1713 \text{ MHz}; f_2 = 1851 \text{ MHz}; V_{CC} = 1.8 \text{ V}.$ 

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$
- (4)  $T_{amb} = +125 \, ^{\circ}C$

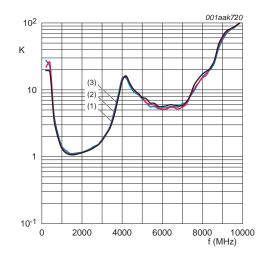
Fig 29. Third order intermodulation distortion and output power as function of input power; typical values



 $V_{CC} = 1.8 \text{ V}; P_i = -45 \text{ dBm}.$ 

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$
- (4)  $T_{amb} = +125 \, ^{\circ}C$

Fig 30. Rollett stability factor as a function of frequency; typical values



 $T_{amb} = 25 \, ^{\circ}C; \, P_i = -45 \, dBm.$ 

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 31. Rollett stability factor as a function of frequency; typical values

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#### SiGe:C Low Noise Amplifier MMIC for GPS

# 8.2 GPS front-end

The GPS LNA is typically used in a GPS front-end. A GPS front-end application circuit and its characteristics is provided here.

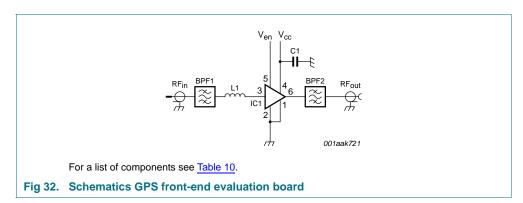


Table 10. List of components
For schematics see Figure 32.

Component	Description	Value	Supplier	Remarks
BPF1, BPF2	GPS SAW filter	-	Murata SAFEA1G57KE0F00	Alternatives from Epcos:
				• B9444
				Alternatives from Murata:
				<ul> <li>SAFEA1G57KH0F00</li> </ul>
				<ul> <li>SAFEA1G57KB0F00</li> </ul>
				Alternatives from Fujitsu:
				<ul> <li>FAR-F6KA-1G5754-L4AA</li> </ul>
				<ul> <li>FAR-F6KA-1G5754-L4AJ</li> </ul>
C1	decoupling capacitor	1 nF	Various	
IC1	BGU7004	-	NXP	
L1	high quality matching inductor	5.6 nH	Murata LQW15A	

#### 8.3 Characteristics GPS front-end

#### Table 11. Characteristics GPS front-end

f = 1575 MHz;  $V_{CC}$  = 1.8 V;  $V_{ENABLE} \ge 0.8$  V; power at LNA input  $P_i$  < -40 dBm;  $T_{amb}$  = 25 °C; input and output matched to 50  $\Omega$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage	RF input AC coupled	1.5	-	2.85	V
I <sub>CC</sub>	supply current		-	4.5	-	mA
Gp	power gain	power at LNA input P <sub>i</sub> < -40 dBm	l -	14.5	-	dB
		power at LNA input $P_i = -20 \text{ dBm}$	<b>-</b>	15.5	-	dB
RLin	input return loss	power at LNA input P <sub>i</sub> < -40 dBm	l <b>-</b>	8.5	-	dB
		power at LNA input $P_i = -20 \text{ dBm}$	l <b>-</b>	10.5	-	dB
RL <sub>out</sub>		power at LNA input P <sub>i</sub> < -40 dBm	-	14.5	-	dB
		power at LNA input $P_i = -20 \text{ dBm}$	-	12.5	-	dB

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#### SiGe:C Low Noise Amplifier MMIC for GPS

 Table 11.
 Characteristics GPS front-end ...continued

f = 1575 MHz;  $V_{CC} = 1.8$  V;  $V_{ENABLE} \ge 0.8$  V; power at LNA input  $P_i < -40$  dBm;  $T_{amb} = 25$  °C; input and output matched to 50  $\Omega$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
NF	noise figure	power at LNA input $P_i < -40 \text{ dBm}$	<u>[1]</u> -	1.8	-	dB
		power at LNA input P <sub>i</sub> = −20 dBm	[1] _	1.9	-	dB
P <sub>i(1dB)</sub>	input power at 1 dB gain compression	f = 1575 MHz		-8.2		dBm
		f = 806 MHz to 928 MHz	[2]	31		dBm
		f = 1612 MHz to 1909 MHz	[2]	40		dBm
IP3 <sub>i</sub>	input third-order intercept point		[3]	64		dBm
α	attenuation	f = 850 MHz	<u>[4]</u> 95	-	-	dBc
		f = 1850 MHz	<u>[4]</u> 90	-	-	dBc
t <sub>on</sub>	turn-on time		[5]	-	2	μS
t <sub>off</sub>	turn-off time		[5] _	-	1	μS

<sup>[1]</sup> Power at GPS front-end input = power at LNA input + attenuation BPF1.

## 9. Test information

# 9.1 Quality information

All qualification tests are performed according AEC-Q100 except for read point testing (final test of qualification sample). Which is done only at room temperature.

As part of the zero defect program, the following is part of the industrial test flow:

- Part Average Testing
- Maverick Lot Handling at assembly factory

<sup>[2]</sup> Out of band.

<sup>[3]</sup>  $f_1 = 1713 \text{ MHz}$ ;  $f_2 = 1851 \text{ MHz}$ ;  $P_1 = P_2 = +10 \text{ dBm}$ .

<sup>[4]</sup> Relative to f = 1575 MHz.

<sup>[5]</sup> Within 10 % of the final gain.

# 10. Package outline

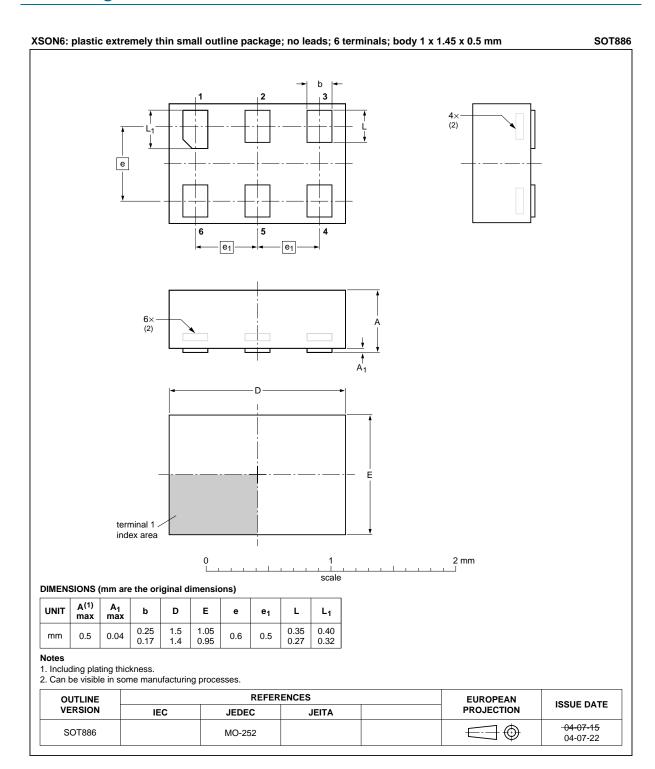


Fig 33. Package outline SOT886 (XSON6)

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# SiGe:C Low Noise Amplifier MMIC for GPS

# 11. Abbreviations

Table 12. Abbreviations

Acronym	Description			
AC	Alternating Current			
AEC	Automotive Electronics Council			
ATM	Automated Teller Machine (cash dispenser)			
BPF	Band-Pass Filter			
GLONASS	GLObal'naya NAvigatsionnaya Sputnikovaya Sistema (GLObal NAvigation Satellite System)			
GNSS	Global Navigation Satellite System			
GPS	Global Positioning System			
НВМ	Human Body Model			
LNA	Low Noise Amplifier			
MMIC	Monolithic Microwave Integrated Circuit			
RF	Radio Frequency			
SAW	Surface Acoustic Wave			
SiGe:C	Silicon Germanium Carbon			

# 12. Revision history

#### Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGU7004 v.1	20110705	Product data sheet	-	-

#### SiGe: C Low Noise Amplifier MMIC for GPS

# 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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# SiGe:C Low Noise Amplifier MMIC for GPS

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